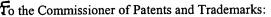
SMITTAL LETTER

KRM-00101



Transmitted herewith for filing under 35 U.S.C. 111 and 37 CFR 1.53 is the patent application of

ਰ Hiroto OHTAKE; Shinobu SAITOH; Munehiro TADA; and Yoshihiro HAYASHI

entitled <u>METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE CAPABLE OF ETCHING A MULTI-</u> LAYER OF ORGANIC FILMS AT A HIGH SELECTIVITY

## Enclosed are:

- X 61 pages of written description, claims and abstract.
- X 25 sheets of drawings.
- X an assignment of the invention to <u>NEC Corporation</u> and check for \$40.00.
- X executed declaration of the inventors.

## **CLAIMS AS FILED**

|                                       |                                                                                                                   | NUMBER FILED | NUMBER EXTRA     | RATE    | FEE    |
|---------------------------------------|-------------------------------------------------------------------------------------------------------------------|--------------|------------------|---------|--------|
| BASIC FEE (37 CFR 1.16(a))            |                                                                                                                   |              |                  | \$740   | \$740  |
| TOTAL CLAIMS (37 CFR 1.16(c))         |                                                                                                                   | 29-20=       | 9                | x \$ 18 | \$162  |
| INDEPENDENT CLAIMS (37 CFR            |                                                                                                                   | 9-3=         | *6               | x \$84  | \$504  |
| 1.16(b))                              |                                                                                                                   |              |                  |         |        |
| MULTIPLE DEPENDENT CLAIM              |                                                                                                                   | (37 CFI      | (37 CFR 1.16(d)) |         |        |
| PRESENT                               |                                                                                                                   |              |                  |         |        |
| * NUMBER EXTRA MUST BE ZERO OR LARGER |                                                                                                                   |              |                  | TOTAL   | \$1406 |
| tage a.a.                             | If applicant has small entity status under 37 CFR 1.9 and 1.27 then divide total fee by 2, and enter amount here. |              | SMALL<br>ENTITY  | \$      |        |

X A check in the amount of \$1406 to cover the filing fee is enclosed.

X The Commissioner is hereby authorized to charge and credit Deposit Account No. 501136 as described below. I have enclosed a duplicate copy of this sheet.

Charge the amount of \$ \_as filing fee.

- X Credit any overpayment.
- X Charge any additional filing fees required under 37 CFR 1.16 and 1.17.

  Charge the issue fee set in 37 CFR 1.18 at the mailing of the Notice of Allowance, pursuant to 37 CFR 1.311(b).

## Certificate of Express Mail

I, do hereby certify that the foregoing documents are being deposited with the United States Postal Service as Express Mail, postage prepaid, "Post Office to Addressee", in an envelope addressed to Commissioner for Patents, Box Patent Applications, Washington, D.C. 20231 on this date of February 22, 2002.

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